



RECOMMENDED MOUNTING HOLE
MAXIMUM PANEL THICKNESS: 5.5MM

NOTES:

1. MATERIALS:

- ① CENTER CONTACT: PHOSPHOR BRONZE, GOLD PLATING
- ② BODY: ZINC ALLOY, NICKEL PLATING
- ③ INSULATOR: PE-606
- ④ MOUNTING POST: BRASS, TIN PLATING
- ⑤ SOLDER TAIL: BRASS WIRE, TIN PLATING

2. UNSPECIFIED TOLERANCE: .XX ±0.25 [0.010]
.X ±0.30 [0.012]

RoHS Compliant

		<small>THE INFORMATION AGE</small>	
<small>XMULTIPLE ASIA 4F, No. 347, Yang Guang St., Neihu, Taipei, Taiwan 11475</small>		<small>XMULTIPLE USA 1420 Los Angeles Ave., Suite G, Simi Valley, CA 93065</small>	
THIS DRAWING IS A CONTROLLED DOCUMENT.		<small>DWG NO: XMRF-MCX-007</small>	
<small>TITLE: 50 OHM BNC R/A PCB/PANEL MOUNT JACK, METAL BODY</small>		<small>DRAWN: RUNES</small>	
<small>PART NO: XMRF-MCX-007</small>		<small>CHKD: JEFF</small>	
		<small>UNIT mm[inch]</small>	<small>SHEET 1 of 1</small>
		<small>REV 01</small>	<small>DATE: Sep.17,07</small>